



VISIBLE LED

1.ELEMENT APPEARANCE

PAGE : 1 / 4

Model No.	Material	Lighting Color	Resin Color
RT3-254PD-TA	GaP/ GaP	Red	Red Diffused

2.ABSOLUTE MAXIMUM RATINGS AT Ta=25°C

Characteristic	Symbol	Rating	Unit
Forward direct current	I _{FM}	25	mA
Reverse voltage	V _{RM}	5	V
Operating temperature	Topr	-40 to +85	°C
Storage temperature	Tstg	-40 to +100	°C
Power dissipation	Pd	70	mW

3.ELECTRO-OPTICAL CHARACTERISTICS AT Ta=25°C

Characteristic	Symbol	Condition	Min.	Typ.	Max.	Unit
Luminous intensity	I _v	IF= 20 mA		0.85		mcd
Forward voltage	V _F	IF= 20 mA		2.3	2.8	V
Reverse current	I _R	V _R =5V			10	μA
Peak emission wavelength	λ _p	IF=20mA		700		nm
Dominant wavelength	λ _d	IF=20mA		-		nm
Viewing angle	2θ 1/2	IF=20mA		140		deg.

※Luminous Intensity Measurement allowance is ±15%

※Forward voltage Measurement allowance is ±0.05V

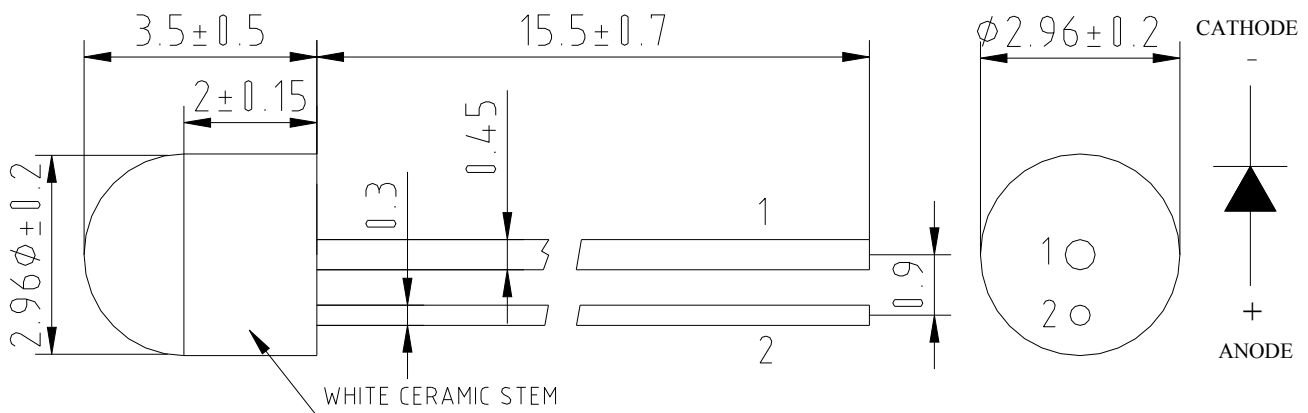
※Peak emission wavelength Measurement allowance is ±0.5nm

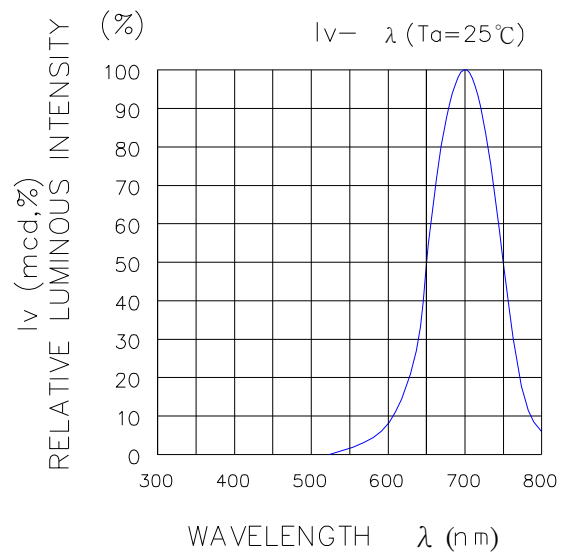
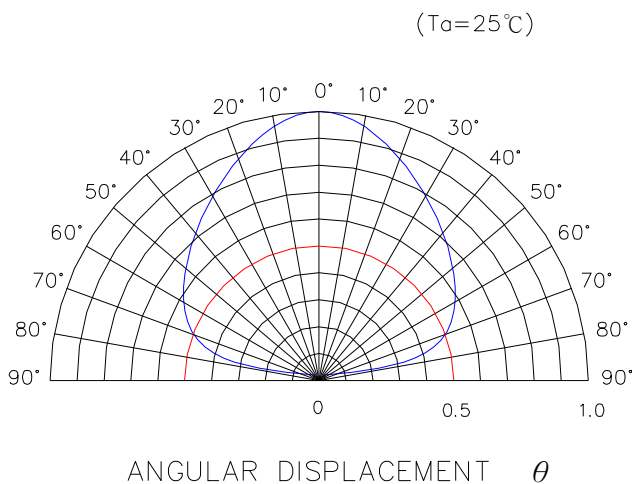
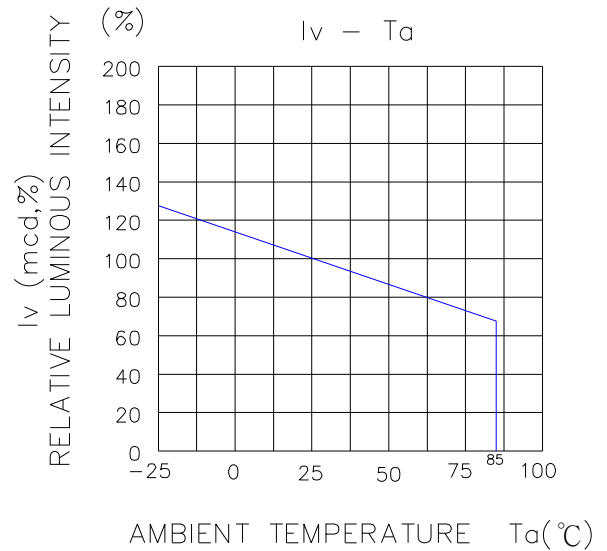
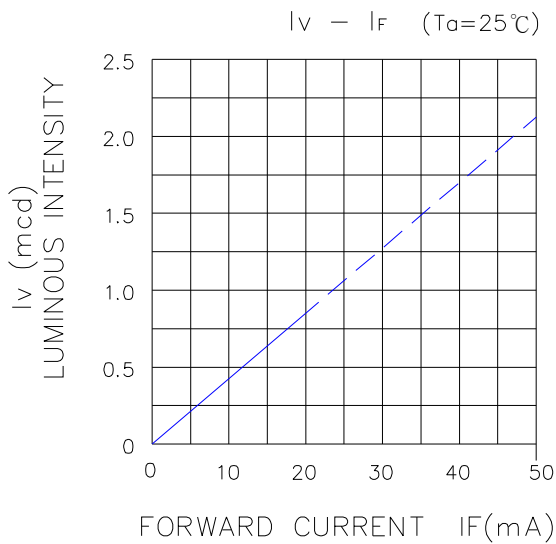
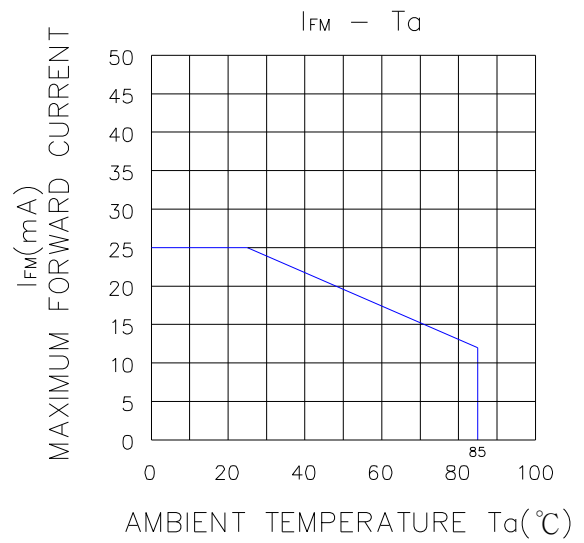
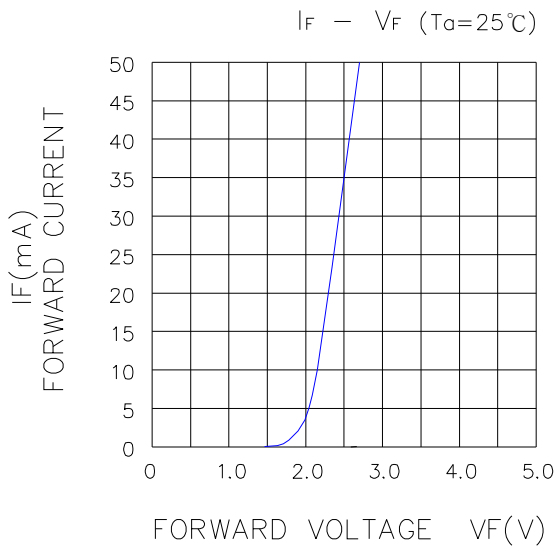
4.DIMENSIONS UNIT : mm

Tolerance is ±0.25mm unless otherwise specified.

SIGN : 1.CATHODE

2.ANODE







Soldering Profile

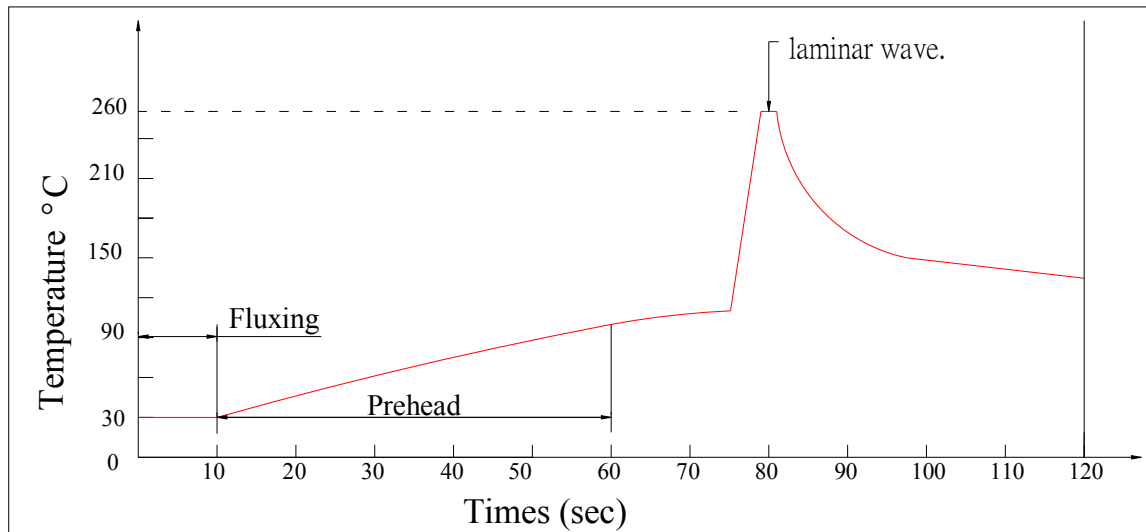
PAGE : 3 / 4

Compliant with the following condition :

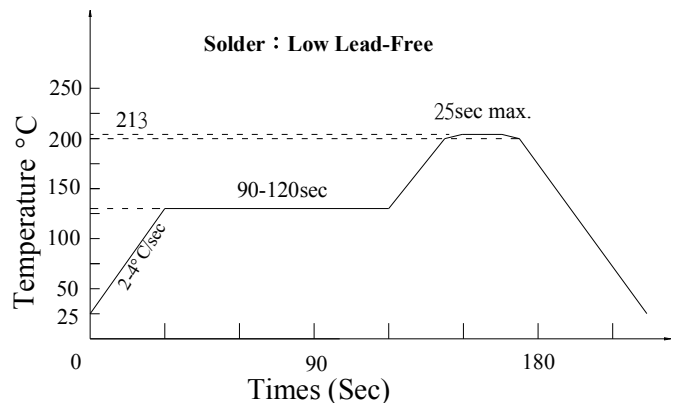
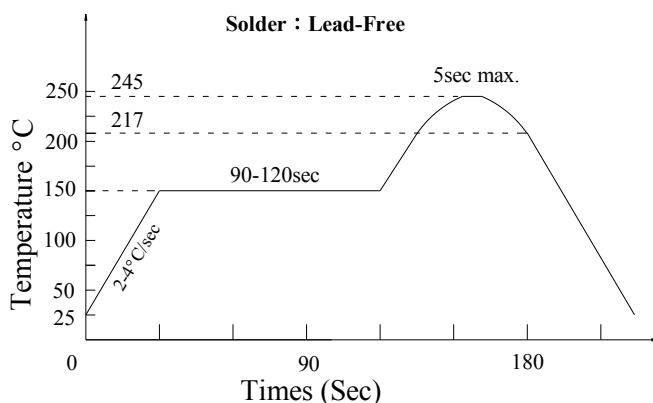
(1) Leaded quantity of product below 100 ppm

(2) Lead-free process

Shape	Lead Frame Type
Hand soldering	1.Temp.at tip of iron : 300 °C max.(30W max.) 2.Soldering time : 3 sec max. 3.Distance : 3 mm MIN (from solder joint to case)
DIP soldering	1.Preheat temp : 100 °C max , 60 sec max. 2.Bath temp : 260 °C max. 3.Bath time : 3 sec max. 4.Distance : 3 mm MIN (From solder joint to case)
Recommended soldering profile	1.Preheat temp. : 100 °C , 50 sec max. 2.Peak temp. : 260 °C max. 3.Peak time : 3 sec max. 4.Duration above: 200°C , 3 sec max.



SMD Type		
Profile Feature	Solder : Lead-Free	Solder : Low Lead-Free
Preheat temp	150-180 °C , 4°C/sec max. 120 sec max.	130-170 °C , 4°C/sec max. 120 sec max.
Peak temp	245 °C max. , 5 sec max.	213 °C max. , 25 sec max.
Duration above	217 °C , 60 sec max.	200 °C , 40 sec max.





Reliability Test Items

PAGE : 4 / 4

CONDITIONS :

The reliability of products shall be satisfied with items listed below.

NO.	<u>Item</u>	Condition	Time / Cycle	Criteria	Ac / Re	Sample Quantity
1	Soldering Heat Test	260°C	5 sec	Open / Short	0 / 1	60 pcs
2	Thermal Shock	0°C (5min) ~100°C (5min)	20 Cycles	Open / Short	0 / 1	60 pcs
3	High Temp. Storage	100°C	1000 Hrs	Open / Short	0 / 1	60 pcs
4	Low Temp. Storage	-40°C	1000 Hrs	Open / Short	0 / 1	60 pcs
5	Temperature Cycle Test	-40°C~85°C	100 Cycles , 200Hrs	Open / Short	0 / 1	60 pcs
6	High Temp. High Humidity Test	60°C , 90% RH	1000Hrs	Open / Short	0 / 1	60 pcs
7	DC Operation Life Test	IF=20mA	1000Hrs	Power decay	≤ 30%	60 pcs